

01-11-2007



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Form PTO-1595 (Rev. 07/05) U.S. DEPARTMENT OF COMMERCE OMB No. 0651-0027 (exp. 6/30/2008) United States Patent and Trademark Office **RECORDATION FORM COVER SHEET** PATENTS ONLY To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below. 1. Name of conveying party(ies) 2. Name and address of receiving party(ies) Siu Keung KWOK; Chi Fai CHEUNG; Hing Choi TSANG; Wing Bun LEE; Name: The Hong Kong Polytechnic University Internal Address: Hung Hom, Kowloon, Hong Kong Burly K. TAN; Pui Him NG Additional name(s) of conveying party(ies) attached? Yes 🗹 No 3. Nature of conveyance/Execution Date(s): Street Address: Hung Hom, Kowloon, Hong Kong Execution Date(s) 1 Dec 2006 Assignment Merger City: Kowloon Security Agreement Change of Name 」Joint Research Agreement Government Interest Assignment Country: Hong Kong Zip: Executive Order 9424, Confirmatory License Additional name(s) & address(es) attached? Yes No 4. Application or patent number(s): This document is being filed together with a new application. A. Patent Application No.(s) B. Patent No.(s) 11/638482 Additional numbers attached? Yes 5. Name and address to whom correspondence 6. Total number of applications and patents concerning document should be mailed: involved:_ Ms. Maquita Wong 7. Total fee (37 CFR 1.21(h) & 3.41) \$___ Internal Address: The Hong Kong Polytechni Authorized to be charged by credit card University Authorized to be charged to deposit account 1800 Diagonal Road T Enclosed Street Address: None required (government interest not affecting title) Suite 600, Mailbox #119 8. Payment Information City: Alexandria a. Credit Card Last 4 Numbers 22314 State: Virginia Zip: Expiration Date 703-647-6569 Phone Number:__ b. Deposit Account Number _ 2333 2410 Fax Number:_ Email Address: pdmaquit@inet.polyu.edu.hk Authorized User Name 9. Signature: Date Signature Total number of pages including cover sheet, attachments, and documents: Sun-wing Lui

Name of Person Signing

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:

Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

01/10/2007 DBYRNE 00000037 11638482 01 FC:8021

In consideration of One Dollar and other good and valuable consideration, of which receipt is acknowledged, I Siu Keung KWOK of The Hong Kong Polytechnic University, sell and assign to The Hong Kong Polytechnic University, a Hong Kong entity, the entire right, title, and interest in and to the invention titled Physimetric Property Identification ... (IP-351A) invented by me as described in the application for United States patent executed by me concurrently herewith, and any and all applications for patent and patents in any and all countries, including all divisions, continuations, reissues, and extensions thereof and all rights of priority resulting from the filing of said United States application and authorize and request any official whose duty it is to issue patents to issue any patent on said improvements or resulting therefrom to said The Hong Kong Polytechnic University, or its successors, assigns, or nominees and agree that on request and without further consideration, but at the expense of The Hong Kong Polytechnic University, I will communicate to the University or its representatives or nominees any facts known to me respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths and generally aid said University, its successors, assigns, and nominees to obtain and enforce proper patent protection for said invention in all countries.

this 151 day of <u>Dec</u> 2006

In consideration of One Dollar and other good and valuable consideration, of which receipt is acknowledged, I __ Chi Fai CHEUNG of The Hong Kong Polytechnic University, sell and assign to The Hong Kong Polytechnic University, a Hong Kong entity, the entire right, title, and interest in and to the invention titled Physimetric Property Identification ... (IP-351A) invented by me as described in the application for United States patent executed by me concurrently herewith, and any and all applications for patent and patents in any and all countries, including all divisions, continuations, reissues, and extensions thereof and all rights of priority resulting from the filing of said United States application and authorize and request any official whose duty it is to issue patents to issue any patent on said improvements or resulting therefrom to said The Hong Kong Polytechnic University, or its successors, assigns, or nominees and agree that on request and without further consideration, but at the expense of The Hong Kong Polytechnic University, I will communicate to the University or its representatives or nominees any facts known to me respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths and generally aid said University, its successors, assigns, and nominees to obtain and enforce proper patent protection for said invention in all countries.

____, this 15t day of <u>Dec</u> 2006

In consideration of One Dollar and other good and valuable consideration, of which receipt is acknowledged, I Hing Choi TSANG of The Hong Kong Polytechnic University, sell and assign to The Hong Kong Polytechnic University, a Hong Kong entity, the entire right, title, and interest in and to the invention titled Physimetric Property Identification ... (IP-351A) invented by me as described in the application for United States patent executed by me concurrently herewith, and any and all applications for patent and patents in any and all countries, including all divisions, continuations, reissues, and extensions thereof and all rights of priority resulting from the filing of said United States application and authorize and request any official whose duty it is to issue patents to issue any patent on said improvements or resulting therefrom to said The Hong Kong Polytechnic University, or its successors, assigns, or nominees and agree that on request and without further consideration, but at the expense of The Hong Kong Polytechnic University, I will communicate to the University or its representatives or nominees any facts known to me respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths and generally aid said University, its successors, assigns, and nominees to obtain and enforce proper patent protection for said invention in all countries.

PATENT REEL: 018775 FRAME: 0286

In consideration of One Dollar and other good and valuable consideration, of which receipt is acknowledged, I Wing Bun LEE of The Hong Kong Polytechnic University, sell and assign to The Hong Kong Polytechnic University, a Hong Kong entity, the entire right, title, and interest in and to the invention titled Physimetric Property Identification ... (IP-351A) invented by me as described in the application for United States patent executed by me concurrently herewith, and any and all applications for patent and patents in any and all countries, including all divisions, continuations, reissues, and extensions thereof and all rights of priority resulting from the filing of said United States application and authorize and request any official whose duty it is to issue patents to issue any patent on said improvements or resulting therefrom to said The Hong Kong Polytechnic University, or its successors, assigns, or nominees and agree that on request and without further consideration, but at the expense of The Hong Kong Polytechnic University, I will communicate to the University or its representatives or nominees any facts known to me respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths and generally aid said University, its successors, assigns, and nominees to obtain and enforce proper patent protection for said invention in all countries. , this | 5 day of <u>Dec</u> 2006

PATENT

In consideration of One Dollar and other good and valuable consideration, of which receipt is acknowledged, I Burly K. TAN of The Hong Kong Polytechnic University, sell and assign to The Hong Kong Polytechnic University, a Hong Kong entity, the entire right, title, and interest in and to the invention titled Physimetric Property Identification ... (IP-351A) invented by me as described in the application for United States patent executed by me concurrently herewith, and any and all applications for patent and patents in any and all countries, including all divisions, continuations, reissues, and extensions thereof and all rights of priority resulting from the filing of said United States application and authorize and request any official whose duty it is to issue patents to issue any patent on said improvements or resulting therefrom to said The Hong Kong Polytechnic University, or its successors, assigns, or nominees and agree that on request and without further consideration, but at the expense of The Hong Kong Polytechnic University, I will communicate to the University or its representatives or nominees any facts known to me respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths and generally aid said University, its successors, assigns, and nominees to obtain and enforce proper patent protection for said invention in all countries.

But Ton , this 1st day of Dec 2006

In consideration of One Dollar and other good and valuable consideration, of which receipt is acknowledged, I Pui Him NG of The Hong Kong Polytechnic University, sell and assign to The Hong Kong Polytechnic University, a Hong Kong entity, the entire right, title, and interest in and to the invention titled Physimetric Property Identification ... (IP-351A) invented by me as described in the application for United States patent executed by me concurrently herewith, and any and all applications for patent and patents in any and all countries, including all divisions, continuations, reissues, and extensions thereof and all rights of priority resulting from the filing of said United States application and authorize and request any official whose duty it is to issue patents to issue any patent on said improvements or resulting therefrom to said The Hong Kong Polytechnic University, or its successors, assigns, or nominees and agree that on request and without further consideration, but at the expense of The Hong Kong Polytechnic University, I will communicate to the University or its representatives or nominees any facts known to me respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths and generally aid said University, its successors, assigns, and nominees to obtain and enforce proper patent protection for said invention in all countries.

, this 15 day of Dec 2006

REEL: 018775 FRAME: 0289

RECORDED: 01/08/2007